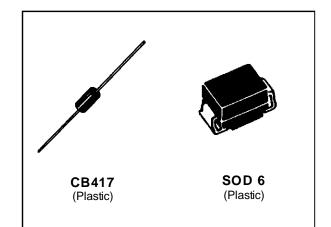


LVT3V3 SMLVT3V3

TRANSIL

FEATURES

- UNDIRECTIONAL TRANSIL DIODE.
- PEAK PULSE POWER= 600 W @ 1ms.
- REVERSE STAND OFF VOLTAGE = 3.3 V.
- LOW CLAMPING FACTOR.
- FAST RESPONSE TIME: Tclamping : 1ps (0 V to VBR).



DESCRIPTION

The LVT3V3 and SMLVT3V3 are dedicated to the protection of the new 3V3 - supplied CMOS and BICMOS technologies.

Their low clamping voltage at high current level guarantee an excellent protection for sensitive components.

MECHANICAL CHARACTERISTICS

- Body Marked With Logo, Type Code And Cathode Band.
- Tinned Copper Leads.
- High Temperature Soldering.

Symbol	Parameter	Value	Unit	
Рp	Peak pulse power dissipation See note 1 and derating curve Fig 1.	Tamb = 25°C	600	W
Р	Power dissipation on infinite heatsink See note 1 and derating curve Fig 1.	Tlead = 75°C	1.7	W
IFSM	Non repetitive surge peak forward current	Tamb = 25°C t =10 ms	50	А
T _{stg} Tj	Storage and junction temperature range	- 65 to + 175 175	°C °C	
Т	Maximum lead temperature for soldering during 10 s.	CB417 SOD 6	230 260	°C ℃

ABSOLUTE RATINGS (limiting values)

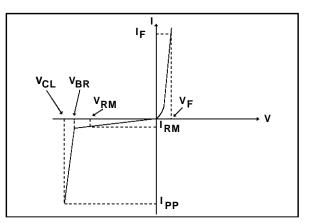
LVT3V3/SMLVT3V3

THERMAL RESISTANCES

Symbol	Parameter	Value	Unit	
R _{th} (j-l)	Junction-leads on infinite heatsink	CB417 SOD 6	20 20	°C/W °C/W

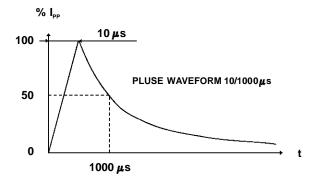
ELECTRICAL CHARACTERISTICS

Symbol	Parameter				
VRM	Stand-off voltage.				
VBR	Breakdown voltage.				
VCL	Clamping voltage.				
IRM	Leakage current @ VRM.				
IPP	Surge current.				
ατ	Voltage temperature coefficient.				



TYPES	I _{RM} @ V _{RM}		V _{BR} @ I _R		V _{CL} @ IPP		VCL @ PP		С	С
	max		min		max		max		max	max
					10/1000µs		8/20µs		note2	note3
	μΑ	V	V	mA	v	A	v	Α	pF	pF
LVT3V3 SMLVT3V3	200	3.3	4.1	1	7.3	50	10	200	5200	3300

All parameters tested at 25 $^\circ\text{C},$ except where indicated.



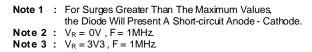
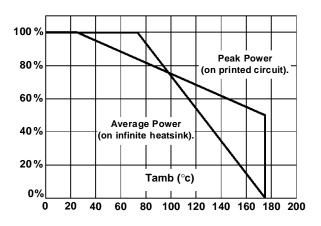


Figure 1 : Power dissipation derating versus ambient temperature





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